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UHF low voltage variable capacitance diode

Rev. 3 — 6 September 2011

Product data sheet

1. Product profile

1.1 General description

The BB184 is a variable capacitance diode, fabricated in planar technology, and encapsulated in the SOD523 (SC-79) ultra small SMD plastic package.

1.2 Features and benefits

- Very steep CV curve
- C_{d(1V)}: 14 pF; C_{d(10V)}: 2 pF
- Arr C_{d(1V)} to C_{d(10V)} ratio: typical 7
- Ultra small SMD plastic package.

1.3 Applications

- Voltage Controlled Oscillators (VCO)
- Tuning in low voltage television.

2. Pinning information

Table 1. Discrete pinning

Pin	Description	Simplified outline	Symbol
1	cathode		JL
2	anode	1 2	sym008

3. Ordering information

Table 2. Ordering information

Type number	Package		
	Name	Description	Version
BB184	-	plastic surface mounted package; 2 leads	SOD523

4. Marking

Table 3. Marking

Type number	Marking code
BB184	A2



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5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{R}	continuous reverse voltage		-	13	V
l _F	continuous forward current		-	10	mA
T _{stg}	storage temperature		-55	+150	°C
Tj	operating junction temperature		-55	+125	°C

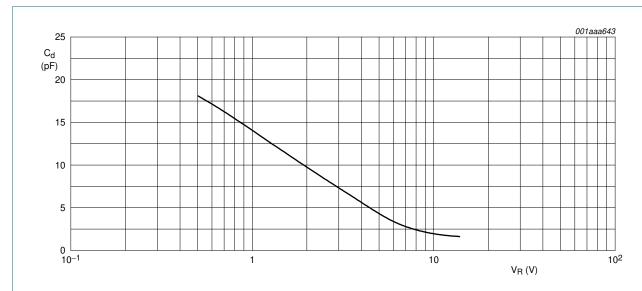
6. Characteristics

Table 5. Electrical characteristics

 T_i = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _R reverse current	V _R = 10 V; see <u>Figure 2</u>	-	-	10	nΑ	
	$V_R = 10 \text{ V}; T_j = 85 \text{ °C}; \text{ see } \frac{\text{Figure 2}}{\text{Minimum 2}}$	-	-	200	nA	
r _s	diode series resistance	$f = 470 \text{ MHz}; C_d = 9 \text{ pF}$	-	0.65	-	Ω
C _d diode capacitance		f = 1 MHz; see Figure 1 and 3				
		V _R = 1 V	12.7	14	15.3	pF
		V _R = 4 V	-	5.5	-	pF
		V _R = 10 V	1.87	2	2.13	pF
$\frac{C_{d(1V)}}{C_{d(10V)}}$	capacitance ratio	f = 1 MHz	6	7	-	
$\frac{\Delta C_d}{C_d}$	capacitance matching	$V_R = 1$ to 10 V; in a sequence of 5 diodes (gliding)	-	-	2	%

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f = 1 MHz; $T_j = 25 \, ^{\circ}\text{C}$.

Fig 1. Diode capacitance as a function of reverse voltage; typical values.

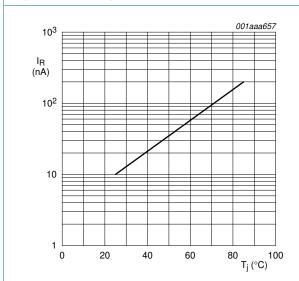


Fig 2. Reverse current as a function of junction temperature; maximum values.

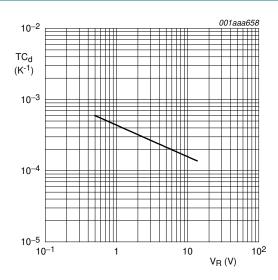


Fig 3. Temperature coefficient of diode capacitance as a function of reverse voltage; typical values.

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7. Package outline

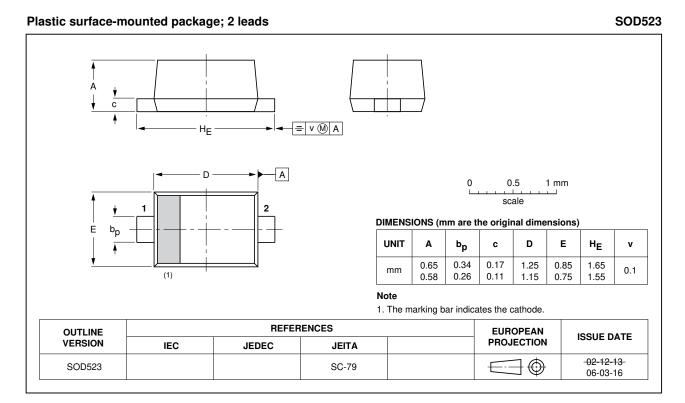


Fig 4. Package outline.

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8. Revision history

Table 6. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BB184 v.3	20110906	Product data sheet	-	BB184 v.2
Modifications:		t of this data sheet has been of NXP Semiconductors.	redesigned to comply v	vith the new identity
	 Legal texts 	have been adapted to the r	new company name whe	ere appropriate.
	 Package o 	utline drawings have been u	pdated to the latest vers	sion.
BB184 v.2 (9397 750 13004)	• Package o 20040422	utline drawings have been u Product data	ipdated to the latest vers	sion. BB184_N v.1

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9. Legal information

9.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions"
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